# Panasonic

DZ4J024K0R

Total power dissipation

Electrostatic discharge

Operating ambient temperature

Junction temperature

Storage temperature

Zener Diode DZ4J024K0R

Silicon epitaxial planar type

### Unit: mm 2.0 For constant voltage / For surge absorption circuit <u>0. 3</u> 0 13 -4 Features Excellent rising characteristics of zener current Iz 25 Low zener operating resistance Rz Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant) 2 1 0.7 Marking Symbol: 1J (0.65)(0.65) 1.3 Basic Part Number : Dual DZ2J024 (Parallel) Packaging 3. Cathode-2 1. Anode-1 Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard) 2. Anode-2 4. Cathode-1 Panasonic SMini4-F3-B Absolute Maximum Ratings Ta = 25 °C JEITA SC-113BB Symbol Rating Unit Code Parameter Repetitive peak forward current IFRM 200 mΑ

200

±15

150

-40 to +85

-55 to +150

mW

kV

°C

°C °C

Internal Connection	

### Note) \*1: Mounted on glass epoxy print board. ( 45 mm x 45 mm x 1 mm) Solder in (0.8 mm x 0.8 mm)

\*2: Test method:IEC61000\_4\_2(C = 150 pF,R = 330 Ω, Contact discharge:10 times)

PT

ESD

Ti

Topr

Tstg

### Electrical Characteristics Ta = 25 °C ± 3 °C Parameter Symbol Conditions Min Max Unit Typ Forward voltage VF IF = 10 mA 1.0 V Zener voltage 1. VZ IZ = 5 mA 2.28 2.52 V Zener operating resistance RZ IZ = 5 mA 100 Ω Reverse current IR VR = 1 V 120 μΑ SZ Temperature coefficient of zener voltage IZ = 5 mA -1.7 mV/°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

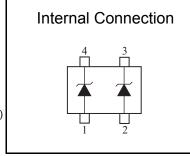
2. Absolute frequency of input and output is 5 MHz.

3. \*1: The temperature must be controlled 25 °C for VZ mesurement.

VZ value measured at other temperature must be adjusted to VZ (25 °C)

\*2: VZ guaranted 20 ms after current flow.

\*3: Tj = 25 °C to 150 °C



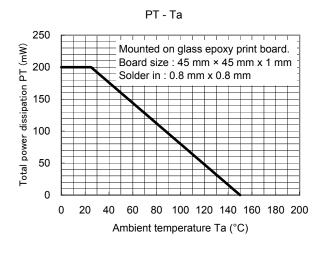
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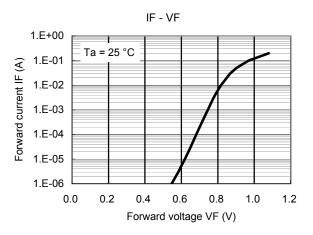


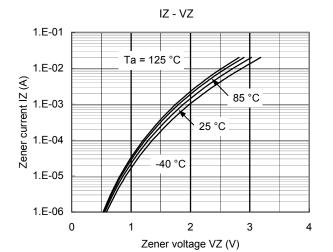


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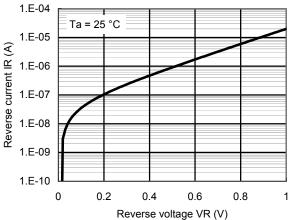
### Technical Data (reference)

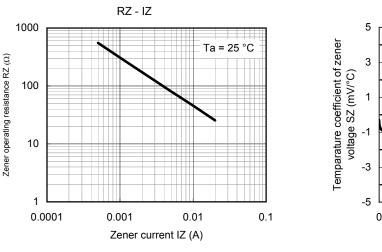


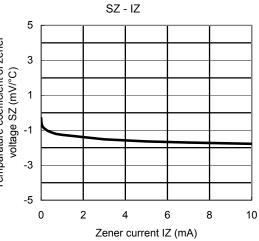








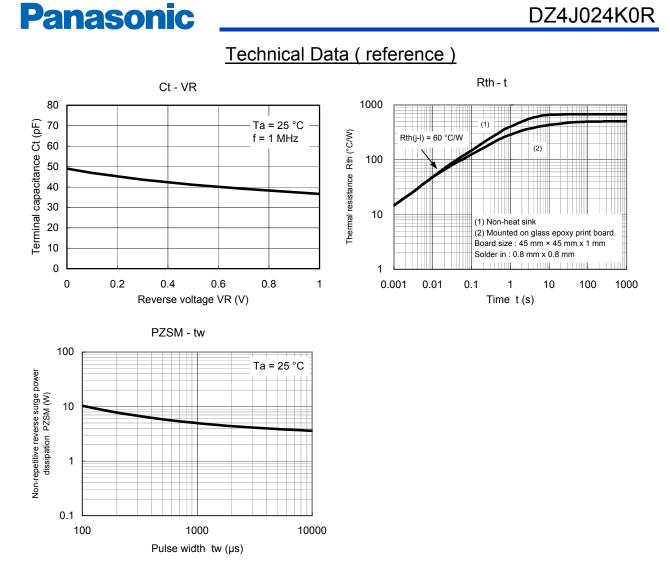


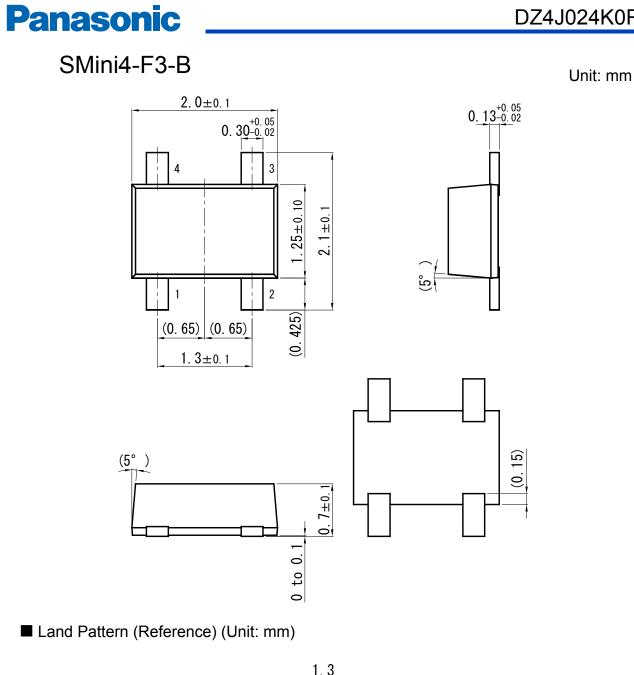


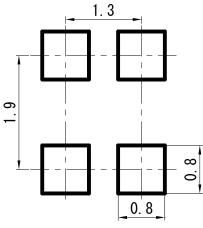
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Established : 2009-12-11 Revised : 2013-10-04

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Zener Diode

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